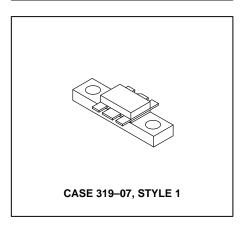
The RF Line NPN Silicon RF Power Transistor

... designed for 24 volt UHF large—signal, common—base amplifier applications in industrial and commercial FM equipment operating in the range of 804–960 MHz.

- Specified 24 Volt, 900 MHz Characteristics
 Output Power = 30 Watts
 Power Gain = 7.0 dB Min
 Efficiency = 55% Min
- Series Equivalent Large-Signal Characterization
- Capable of 30:1 VSWR Load Mismatch at Rated Output Power and Supply Voltage
- Gold Metallized, Emitter Ballasted for Long Life and Resistance to Metal Migration
- · Silicon Nitride Passivated

MRF894

30 W, 900 MHz RF POWER TRANSISTOR NPN SILICON



MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	VCEO	30	Vdc
Collector-Base Voltage	V _{CBO}	50	Vdc
Emitter–Base Voltage	VEBO	4.0	Vdc
Collector Current — Continuous	IC	7.0	Adc
Total Device Dissipation @ T _C = 25°C (1) Derate above 25°C	PD	115 0.66	Watts W/°C
Storage Temperature Range	T _{stg}	-65 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case (2)	$R_{\theta JC}$	1.5	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS	_				
Collector–Emitter Breakdown Voltage (I _C = 25 mAdc, I _B = 0)	V(BR)CEO	30	_	_	Vdc
Collector–Emitter Breakdown Voltage (I _C = 25 mAdc, V _{BE} = 0)	V(BR)CES	50	_	_	Vdc
Emitter–Base Breakdown Voltage ($I_E = 5.0 \text{ mAdc}, I_C = 0$)	V(BR)EBO	4.0	_	_	Vdc
Collector Cutoff Current (V _{CB} = 30 Vdc, I _E = 0)	I _{CBO}	_	_	10	mAdc

NOTES:

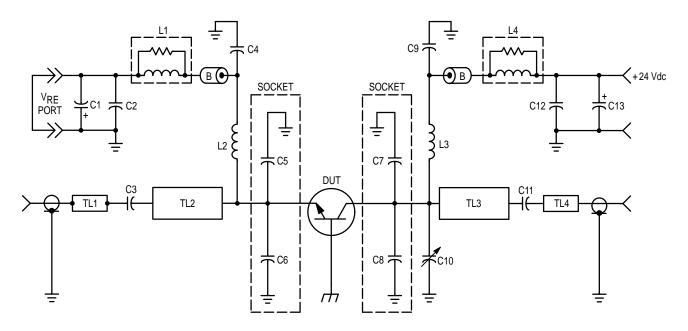
(continued)

- 1. This device is designed for RF operation. The total device dissipation rating applies only when the device is operated as an RF amplifier.
- 2. Thermal Resistance is determined under specified RF operating conditions by infrared measurement techniques.



ELECTRICAL CHARACTERISTICS — **continued** $(T_C = 25^{\circ}C)$ unless otherwise noted.)

Characteristic	Symbol	Min	Тур	Max	Unit
ON CHARACTERISTICS					
DC Current Gain (IC = 2.0 Adc, VCE = 5.0 Vdc)	hFE	10	_	120	_
DYNAMIC CHARACTERISTICS					
Output Capacitance $(V_{CB} = 30 \text{ Vdc}, I_E = 0, f = 1.0 \text{ MHz})$	C _{ob}	_	45	_	pF
FUNCTIONAL TESTS					
Common–Base Amplifier Power Gain (Pout = 30 W, V _{CC} = 24 Vdc, f = 900 MHz)	GPE	7.0	8.5	_	dB
Collector Efficiency (P _{Out} = 30 W, V _{CC} = 24 Vdc, f = 900 MHz)	η	55	60	_	%



B — Ferrite Bead, Ferroxcube 56-590-65-3B

C1, C13 — 5.0 $\mu\text{F},\,50~\text{Vdc}$

C2, C12 — 1000 pF Unelco C3, C11 — 47 pF, 100 Mil Chip Capacitor

C4, C9 — 91 pF, Mini–Underwood

C5, C6 — 12 pF, Mini-Underwood

C7 — 18 pF, Mini-Underwood

C8 — 24 pF, Mini-Underwood

C10 — 0.8-8.0 pF Johanson Gigatrim

L1, L4 — 11 Turns #20 Enameled Over 10 Ω Carbon Resistor

L2, L3 — 4 Turns #20 Enameled, .15" ID

TL1, TL4 — Micro Strip Line, 50 Ω

TL2 — Micro Strip, Z_0 = 30 Ω , $\lambda/4$ @ 875 MHz TL3 — Micro Strip, Z_0 = 22 Ω , $\lambda/4$ @ 875 MHz

Board — 0.032" Glass Teflon

2 oz. Cu CLAD, ϵ_{r} = 2.55

Figure 1. 850-900 MHz Broadband Circuit Schematic

TYPICAL CHARACTERISTICS

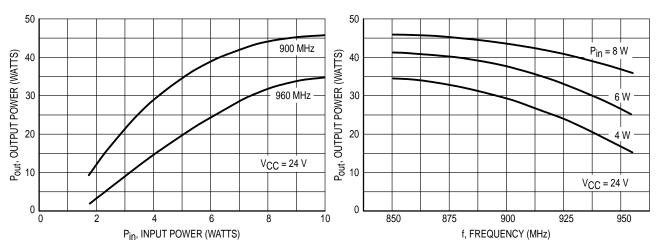


Figure 2. Output Power versus Input Power

Figure 3. Output Power versus Frequency

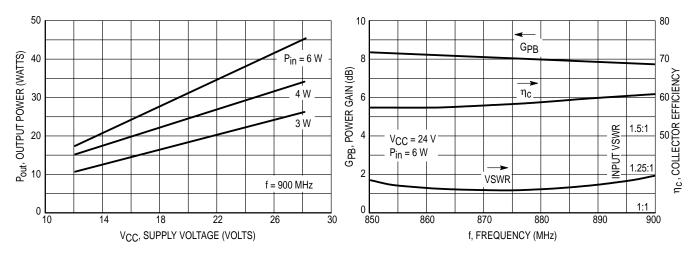
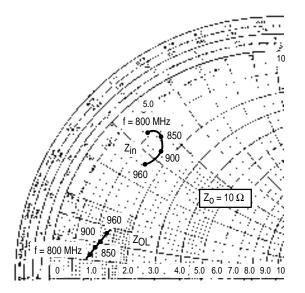


Figure 4. Output Power versus Supply Voltage

Figure 5. Typical Broadband Circuit Performance



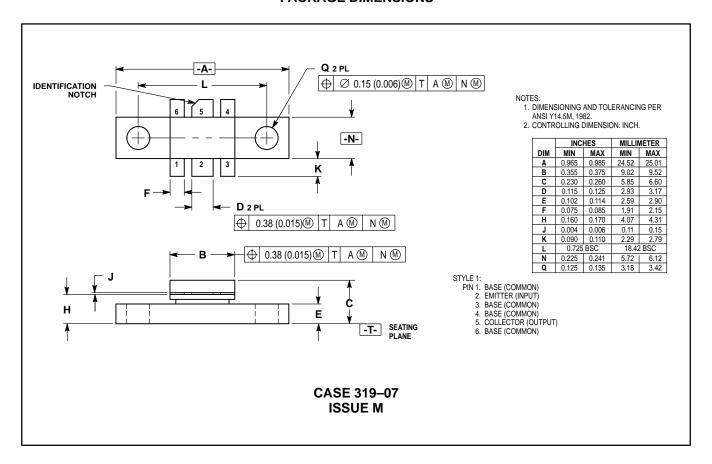
V_{CC} = 24 Vdc, P_{out} = 30 W

f Frequency MHz	Z _{in} Ohms	Z _{OL} * Ohms
800	0.9 + j4.5	1.0 + j0.7
850	1.3 + j4.7	1.1 + j0.9
900	1.6 + j4.4	1.2 + j1.1
960	1.5 + j3.7	1.2 + j1.3
	MHz 800 850 900	MHz Ohms 800 0.9 + j4.5 850 1.3 + j4.7 900 1.6 + j4.4

Z_{OL}* = Conjugate of the optimum load impedance into which the device output operates at a given output power, voltage and frequency.

Figure 6. Series Equivalent Impedance

PACKAGE DIMENSIONS



MOTOROLA RF DEVICE DATA

MRF894

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